

SJ-509ES

Crosslinkable Semiconductive Shielding Compound

Overview

SJ-509ES is a specially formulated crosslinkable semiconductive polyethylene copolymer compound for strippable insulation shielding of medium voltage EPR insulated power cable. (up to 46 kV).

SJ-509ES is specifically developed to provide a super-smooth surface yielding virtually perfect interface between the extruded shield and the and the insulation.

SJ-509ES has stable volume resistivity characteristics at elevated temperatures.

Specifications

ICEA S-93-639, ICEA S-94-649 IEC 60502-2

AEIC CS8 UL 1072

Properties

This TDS is typiacal data only and are not to be construed as specifications. Users should results their own test. Tests are conducted on compression molded slabs cured 15 minutes at 180℃.

Physical density Moisture Content Melt Flow Rate[125°C(257°F)/10.0 kg] Stripping Force[with EPR, 250mm/min, width 10mm, 23°C, 180angle] Brittleness temperature Metal ion content	Value (English) 1.16 g/m³ 500 ppm 0.90 g/10min 11.43 lbs/in <-40 °C <500 ppm	Value (SI) 1.16 g/m³ 500 ppm 0.90 g/10min 2.00 kN/m <-40 °C <500 ppm	Test Method ASTM D 1505 ASTM D 6869 ASTM D 1238 ASTM D 903 ASTM D 746
Mechanical Ultimate Tensile Strength Elongation at Break Retention of Tensile Strength After Ageing - 135°C[275°F], 168hrs Retention of Elongation After Ageing - 135°C[275°F], 168hrs	Value (English) 1740 psi 250 % 90 % 90 %	Value (SI) 12.0 Mpa 250 % 90 % 90 %	Test Method ASTM D 638 ASTM D 638 ASTM D 638 ASTM D 638
Electrical Volume Resistyvity at 23 °C [73.4°F] at 90 °C [194°F] at 135 °C [275°F]	Value (English) 300 Ωcm 1,000 Ωcm 3,000 Ωcm	Value (SI) 300 Ωcm 1,000 Ωcm 3,000 Ωcm	Test Method ASTM D 991

Product Data sheet

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Processing

SJ-509ES provides excellent surface finish and outstanding output rates over a broad range of extrusion a broad range of extrusion conditions.

SJ-509ES requires melt stock temperatures in the range of 110 °C to 120 °C for best results. Lower melt temperatures may result in a unmelt extrudate and higher melt temperatures may result in extrudate scorch and It can even trigger die-drools.

The curing configuration the maximum cable surface temperature in the curing zone should be maintained below 200°C (392 °F). If the surface temperature of the cable in the curing zone is over 200°C, it may cause cracks in the cable, so careful temperature control required. Dehumidified hopper drying at 25~40 °C for upto 4 hours prior to extrusion might be employed to remove moisture. Specific processing conditions depend on equipments and cable dimensions. Optimum conditions by conventional practices should be established.

Packing & Storage

Packed in 600kg polybag lined carton box.

Recommended maximum storage period is 12months unopened and in original packaging after the manufacture.

Stored at room temperatures

73 °F

23 ℃

The shelf life of this product is 1 year from the date of manufacture.

Safety

Please contact Seji Chemical for Material Data Sheet and Safety.

Disclaimer

Information contained in this data sheet is up-to-date and correct as at the date of issue.

Seji chemical Co., Ltd. cannot control or anticipate the conditions under which this product may be used, each user should review the information in specific context of the planned use.

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